



# BERGQUIST LIQUI FORM TLF 6000HG

March 2020

## PRODUCT DESCRIPTION

Thermally Conductive, One-Part, Liquid Formable Gel Material.

<b>Technology</b>	Silicone
<b>Appearance</b>	Gray paste
<b>Application</b>	Thermal management, Gel (1K)
<b>Application Method</b>	Dispense from cartridge
<b>Operating Temperature Range</b>	-60 to 200°C

## FEATURES AND BENEFITS

- Thermal Conductivity: 6.0 W/m-K
- Dispensable pre-cured gel
- Stable viscosity in storage and in the application
- Excellent chemical stability and mechanical stability

BERGQUIST LIQUI FORM TLF 6000HG thermally conductive gel interface material is designed to meet the demanding requirements in certain telecom market applications. Its unique formulation assures a balanced mix of high thermal conductivity, good dispensing efficiency and high thermal reliability.

This material is specially designed to provide effective electronic component cooling capability for 5G base station and remote antenna assembly where a highly reliable vertical gap stability is required. It is most effective for gaps as narrow as  $\leq 3$ mm. BERGQUIST LIQUI FORM TLF 6000HG is pre-cured, requiring no mixing or refrigeration.

## TYPICAL APPLICATIONS

- RRU/AAU/BBU in wireless in telecom wireless infrastructure
- Filling various gaps between heat-generating devices to heat sinks
- Devices requiring low assembly pressure
- High value assemblies with rework

## TYPICAL PROPERTIES OF UNCURED MATERIAL

Density, ASTM D792, g/cc 3.2  
Shelf Life @ 25°C, days 365

## TYPICAL PROPERTIES OF CURED MATERIAL

### Physical Properties

Viscosity, Pa·s:  
 Low shear rate  $1.0 \text{ s}^{-1}$ , ASTM D2196 2,716  
 High shear rate  $100 \text{ s}^{-1}$ , ASTM D5099 617  
 Dispense Rate, EFD 30cc syringe, 90psi <sup>(1)</sup>, grams/minute <sup>(1)</sup> 17  
 Outgassing, % total mass loss, ASTM E595, % 0.16  
 Flammability Rating, UL 94 V-0

### Electrical Properties

Volume Resistivity, 500 V DC, ASTM D257, ohm-meter  $4.37 \times 10^{11}$   
 Dielectric Strength, ASTM D149, V/mm 10,500  
 Dielectric Constant @ 1,000 Hz 7.95

### Thermal Properties

Thermal Conductivity, ASTM D5470, W/(m-K) 6.0

(1) 30cc syringe, 90 psi (621 kPa), 0.100" orifice no attachment

## GENERAL INFORMATION

**For safe handling information on this product, consult the Safety Data Sheet, (SDS).**

### Not for product specifications

The technical data contained herein are intended as reference only. Please contact your local quality department for assistance and recommendations on specifications for this product.

## CONFIGURATIONS AVAILABLE

BERGQUIST LIQUI FORM TLF 6000HG is supplied in:

Cartridges	150 cc 300 cc
Pail	1 gal 5 gal

## STORAGE

Store product in the unopened container in a dry location. Storage information may be indicated on the product container labeling.

Optimal Storage: 25°C for a 365 day shelf life, in sealed containers with moisture barrier packaging.



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**Conversions**

$(^{\circ}\text{C} \times 1.8) + 32 = ^{\circ}\text{F}$   
 $\text{kV/mm} \times 25.4 = \text{V/mil}$   
 $\text{mm} / 25.4 = \text{inches}$   
 $\text{N} \times 0.225 = \text{lb/F}$   
 $\text{N/mm} \times 5.71 = \text{lb/in}$   
 $\text{psi} \times 145 = \text{N/mm}^2$   
 $\text{MPa} = \text{N/mm}^2$   
 $\text{N}\cdot\text{m} \times 8.851 = \text{lb}\cdot\text{in}$   
 $\text{N}\cdot\text{m} \times 0.738 = \text{lb}\cdot\text{ft}$   
 $\text{N}\cdot\text{mm} \times 0.142 = \text{oz}\cdot\text{in}$   
 $\text{mPa}\cdot\text{s} = \text{cP}$

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